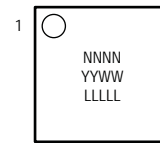
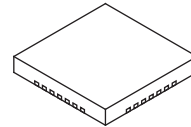
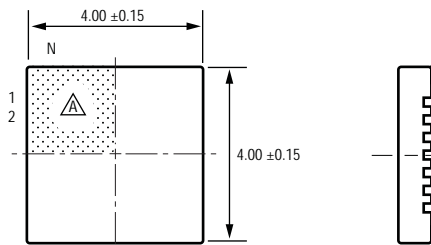


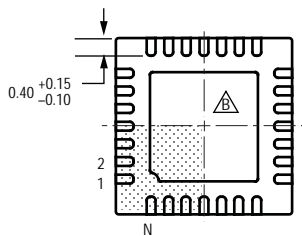
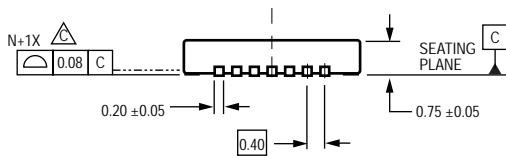
Designator: EC
Type: QFN

Package type representative configuration.
 For contact count and device reference dimensions,
 refer to the datasheet for the individual device







 Standard Branding Reference View

N = Last two digits of device part number
 Y = Last two digits of year of manufacture
 W = Week of manufacture
 L = Lot number



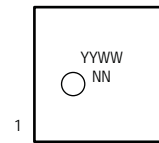
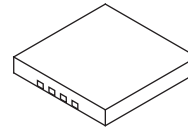
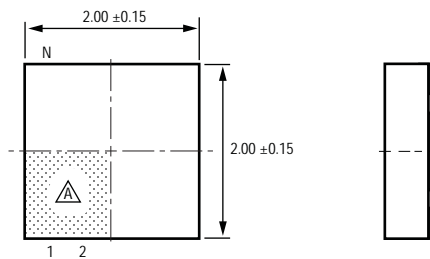
For Reference Only
 (reference JEDEC MO-220)
 Dimensions in millimeters
 Exact case and lead configuration at supplier discretion

-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion

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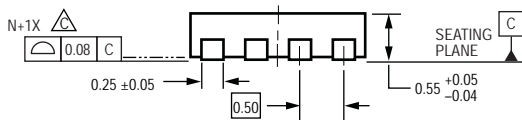
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Type: DFN

Package type representative configuration.
 For contact count and device reference dimensions,
 refer to the datasheet for the individual device

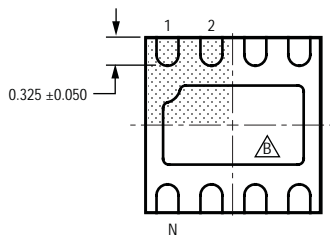






 Standard Branding Reference View

N = Last two digits of device part number
 Y = Last two digits of year of manufacture
 W = Week of manufacture



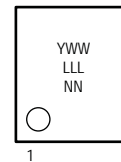
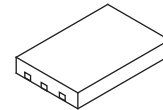
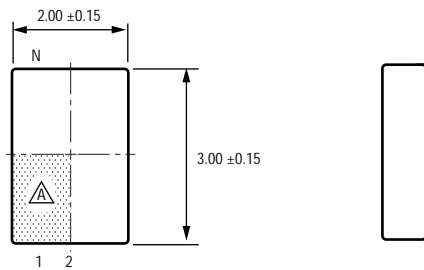
For Reference Only
 (reference JEDEC MO-229)
 Dimensions in millimeters
 Exact case and lead configuration at supplier discretion



-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion

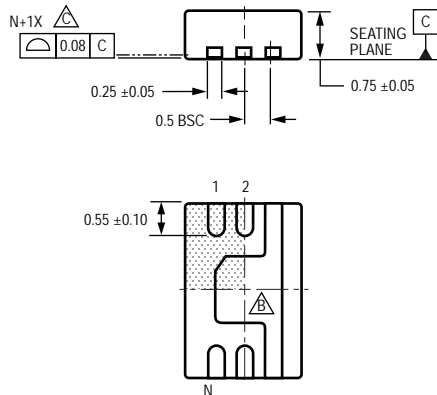
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Package type representative configuration.
For contact count and device reference dimensions,
refer to the datasheet for the individual device







 Standard Branding Reference View

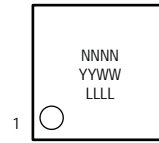
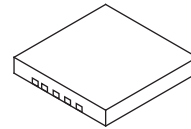
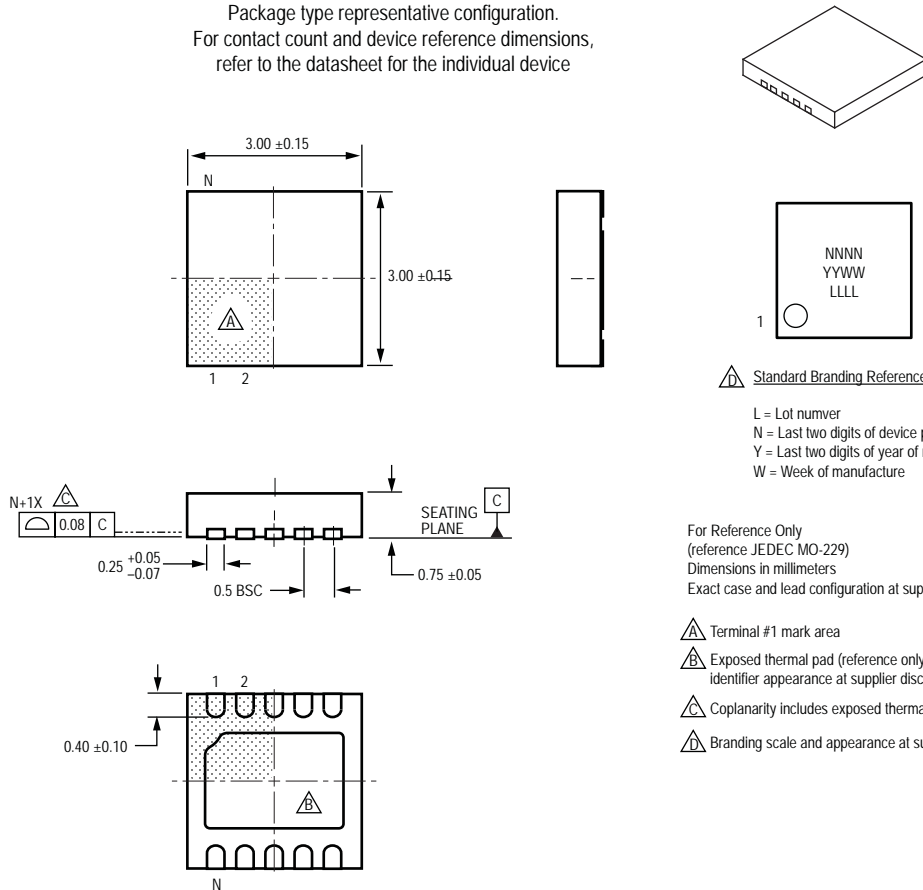
Y = Last two digits of year of manufacture
W = Week of manufacture
L = Lot number
N = Last two digits of device part number



For Reference Only
(reference JEDEC MO-229)
Dimensions in millimeters
Exact case and lead configuration at supplier discretion

-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion





Package type representative configuration.
 For contact count and device reference dimensions,
 refer to the datasheet for the individual device



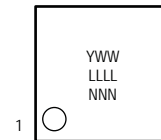
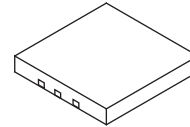
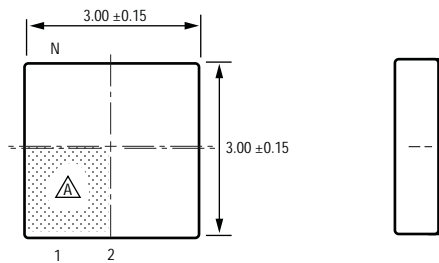
 Standard Branding Reference View

L = Lot number
 N = Last two digits of device part number
 Y = Last two digits of year of manufacture
 W = Week of manufacture

For Reference Only
 (reference JEDEC MO-229)
 Dimensions in millimeters
 Exact case and lead configuration at supplier discretion

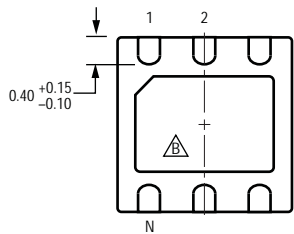
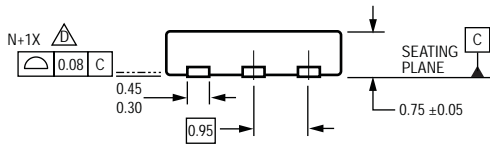
-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion

Package type representative configuration.
For contact count and device reference dimensions,
refer to the datasheet for the individual device







 Standard Branding Reference View

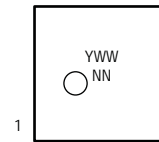
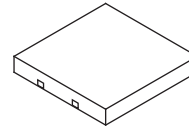
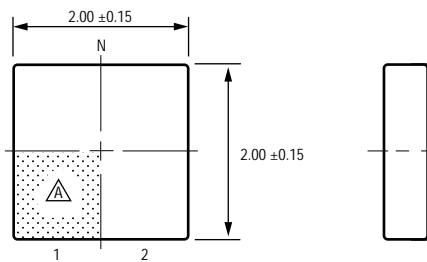
L = Lot number
N = Last two digits of device part number
Y = Last two digits of year of manufacture
W = Week of manufacture



For Reference Only
(reference JEDEC MO-229)
Dimensions in millimeters
Exact case and lead configuration at supplier discretion

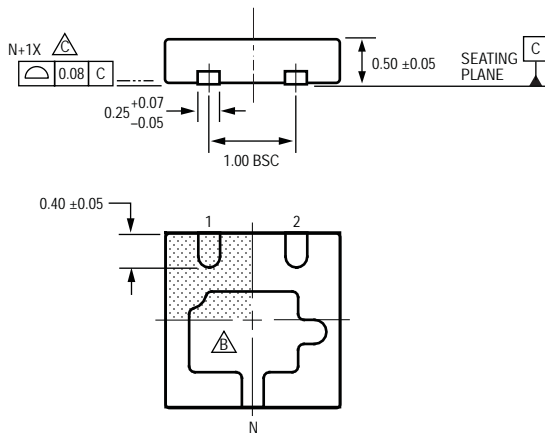
-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion

Package type representative configuration.
For contact count and device reference dimensions,
refer to the datasheet for the individual device







 Standard Branding Reference View

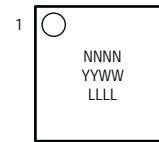
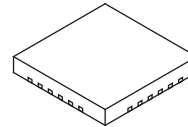
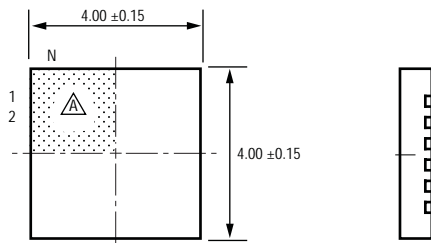
N = Last two digits of device part number
Y = Last two digits of year of manufacture
W = Week of manufacture



For Reference Only
(reference JEDEC MO-229)
Dimensions in millimeters
Exact case and lead configuration at supplier discretion

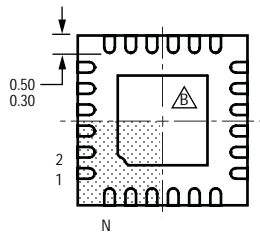
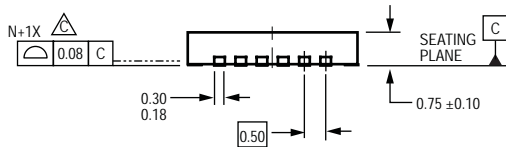
-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion

Package type representative configuration.
For contact count and device reference dimensions,
refer to the datasheet for the individual device







 Standard Branding Reference View

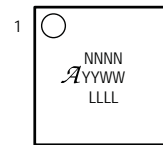
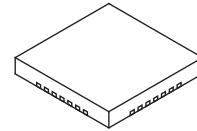
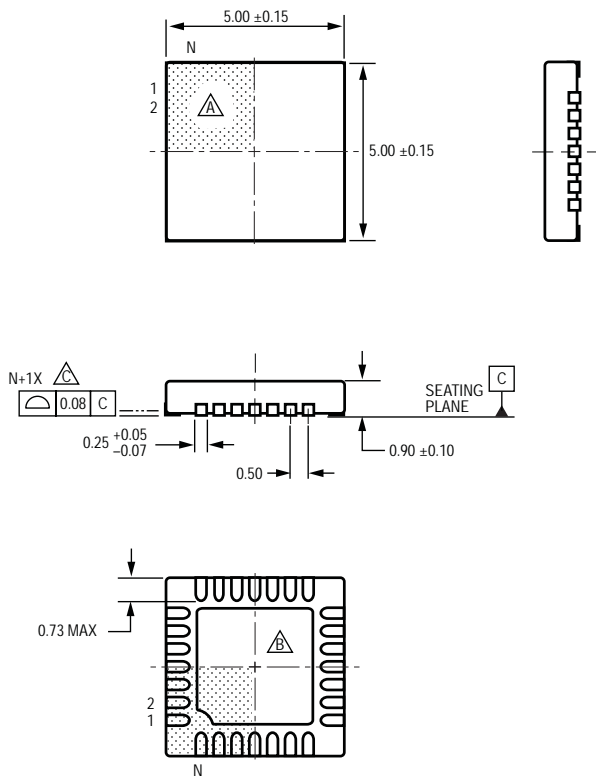
L = Lot number
N = Last two digits of device part number
Y = Last two digits of year of manufacture
W = Week of manufacture



For Reference Only
(reference JEDEC MO-220)
Dimensions in millimeters
Exact case and lead configuration at supplier discretion

-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion





Package type representative configuration.
For contact count and device reference dimensions,
refer to the datasheet for the individual device



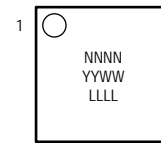
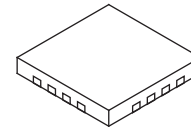
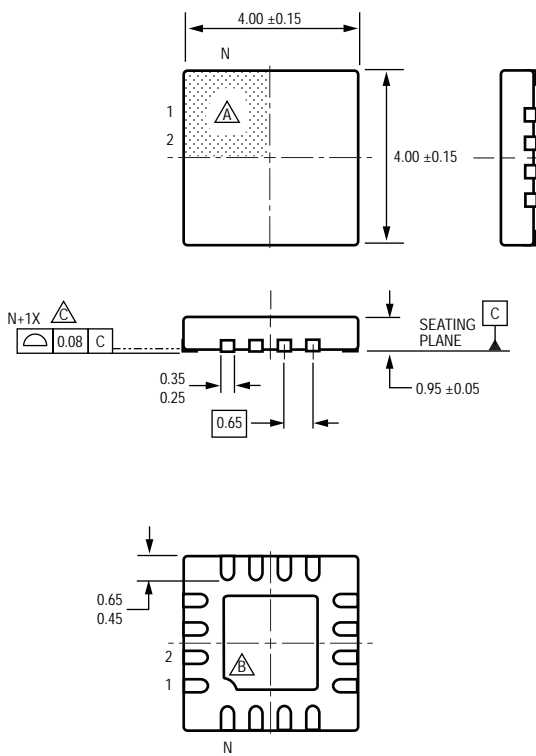
 Standard Branding Reference View

A = Supplier emblem
L = Lot identifier
N = Device part number
Y = Last two digits of year of manufacture
W = Week of manufacture

For Reference Only
(reference JEDEC MO-220)
Dimensions in millimeters
Exact case and lead configuration at supplier discretion

-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion





Package type representative configuration.
For contact count and device reference dimensions,
refer to the datasheet for the individual device



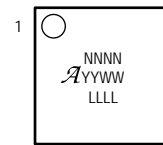
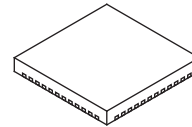
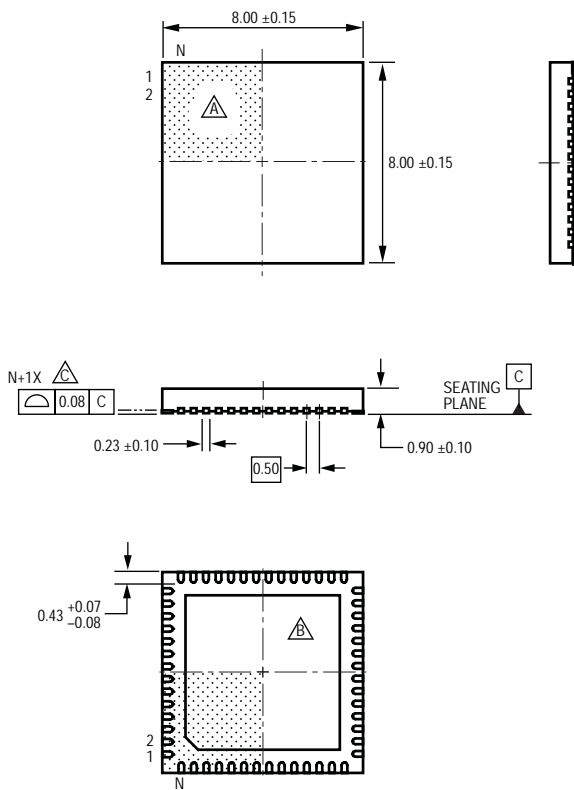
 Standard Branding Reference View

L = Lot identifier
N = Device part number
Y = Last two digits of year of manufacture
W = Week of manufacture

For Reference Only
(reference JEDEC MO-220)
Dimensions in millimeters
Exact case and lead configuration at supplier discretion

-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion





Package type representative configuration.
For contact count and device reference dimensions,
refer to the datasheet for the individual device



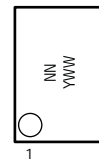
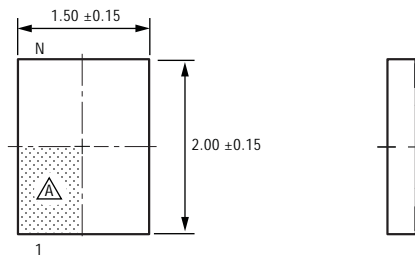
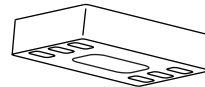
 Standard Branding Reference View

A = Supplier emblem
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N = Device part number
Y = Last two digits of year of manufacture
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For Reference Only
(reference JEDEC MO-220)
Dimensions in millimeters
Exact case and lead configuration at supplier discretion

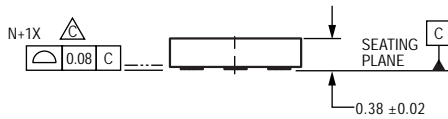
-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion

Package type representative configuration.
For contact count and device reference dimensions,
refer to the datasheet for the individual device

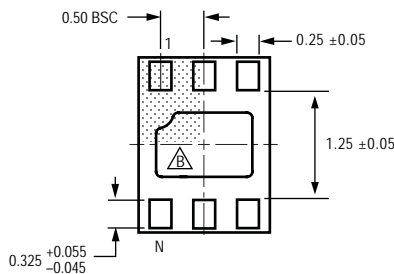






 Standard Branding Reference View

N = Device part number
Y = Last two digits of year of manufacture
W = Week of manufacture



For Reference Only
(reference JEDEC MO-229)
Dimensions in millimeters
Exact case and lead configuration at supplier discretion



-  Terminal #1 mark area
-  Exposed thermal pad (reference only, terminal #1 identifier appearance at supplier discretion)
-  Coplanarity includes exposed thermal pad and terminals
-  Branding scale and appearance at supplier discretion

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